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TO THE HONORABLE DIRECTOR, PATENT AND TRADEMARK OFFICE. PLEASE RECORD THE ATTACHED ORIGINAL DOCUMENTS ON THIS COVER SHEET.

<p>1. Name of conveying parties:</p> <p>(a) PARK, Myung-Jae; (b) RHEE, Young-Joon; (c) PARK, Hyeong-Jun; (d) KONG, Hyang-Shik</p> <p>Additional name(s) of conveying party(ies) attached?</p> <p><input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>	<p>2. Name and address of receiving party:</p> <p>Name: SAMSUNG ELECTRONICS CO., LTD. Address: 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea</p> <p>Additional name(s) of receiving party(ies) attached?</p> <p><input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
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3. Nature of Conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: February 2, 2005

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s) <u>10/991,610</u> Title: <u>THIN FILM PANEL</u>	B. Patent No.(s)
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Additional numbers attached? Yes No

<p>5. Name and address of party to whom correspondence concerning document should be mailed:</p> <p>Name: <u>David W. Heid</u> Internal Address: <u>MACPHERSON, KWOK CHEN & HEID LLP</u> Street Address: <u>1762 Technology Drive, Suite 226</u> City <u>San Jose</u> State <u>CA</u> Zip <u>95110</u></p>	<p>6. Total number of applications and patents involved: <u>One</u></p> <p>7. Total fee (37 CFR 3.41): \$40.00</p> <p><input checked="" type="checkbox"/> Authorized to be charged to Deposit Account No. 50-2257. <input checked="" type="checkbox"/> Charge Deposit Account No. 50-2257 for any additional fees required for this conveyance and credit Deposit Account No. 50-2257 any amounts overpaid</p>
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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David W. Heid 25,875 David W. Heid Feb. 25, 2005
Name of Person Signing Signature Date

Total number of pages comprising cover sheet: 4

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ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

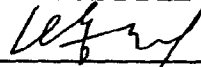
PARK, Myung-Jae	of	Byejeokgol 8-danji Jookong Apt. 841-1804, Yeongtong-dong, Paldal-gu,, Suwon-si, Gyeonggi-do, Korea
RHEE, Young-Joon	of	Cheongsol Woosung Apt. 105-1606, Dapsimri 2-dong, Dongdaemun-gu, Seoul, Korea
PARK, Hyeong-Jun	of	127-17, Sinlim 2-dong, Gwanak-gu, Seoul, Korea
KONG, Hyang-Shik	of	Sannamusil Shinwon Apt. 644-304, Yeongtong-dong, Paldal-gu, Suwon-si, Gyeonggi-do, Korea

hereby sell, assign and transfer to SAMSUNG ELECTRONICS CO., LTD., a corporation, having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea, its successors and assigns, the entire right, title and interest throughout the world in our invention in

THIN FILM PANEL

for which we filed a United States Patent Application on November 17, 2004, which now has Serial No. 10/991,610, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from us; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, their successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 2nd day of February, 2005.



PARK, Myung-Jae

WITNESSED:

KIM, Dae-Shig
Signature

February 2, 2005
Date

KIM, Dae-Shig
Type or print name of witness

Executed this 2nd day of February, 2005.

Rhee, Young-Joon
RHEE, Young-Joon

WITNESSED:

KIM, Dae-Shig
Signature

February 2, 2005
Date

KIM, Dae-Shig
Type or print name of witness

Executed this 2nd day of February, 2005.

Park, Hyeong-Jun
PARK, Hyeong-Jun

WITNESSED:

KIM, Dae-Shig
Signature

February 2, 2005
Date

KIM, Dae-Shig
Type or print name of witness

Executed this 2nd day of February, 2005.

Hong, Hyang-Shik
KONG, Hyang-Shik

WITNESSED:

Signature KIM, Dae-Shig

Date February 2, 2005

Type or print name of witness KIM, Dae-Shig